Zynq-7000 All Programmable SoC Architecture Porting Quick Start Guide

UG1181 (v1.1.1) October 22, 2015





Revision History

The following table shows the revision history for this document.

Date	Version	Revision
10/22/2015	1.1.1	Updated title.
08/31/2015	1.1	Updated the TrustZone section.
06/25/2015	1.0	Initial Xilinx release.



Table of Contents

Revision History	2
Chapter 1: Introduction	
Chapter 2: Porting Considerations	
ARM Cortex-A9 Features	6
Chapter 3: Feature Comparison Across Architectures	
Architectural Comparison	13
Address Maps	18
Detailed Porting Guides: MIPS, PowerPC, Intel, and Renesas	24
Appendix A: Additional Resources and Legal Notices	
Xilinx Resources	25
Solution Centers	25
References	25
Please Read: Important Legal Notices	25

www.xilinx.com





Introduction

This document supports Xilinx® Zynq®-7000 All Programmable (AP) SoC customers that want to port embedded software from non ARM based processors to an ARM processing architecture. This porting guide references documentation on porting for PowerPC®, Intel®, Renesas-SH, and MIPS processors to ARM processors. (Zynq-7000 AP SoC contains the ARM® Cortex®-A9 dual core processor.)

The ARM Cortex-A9 processor is a popular general purpose choice for low-power or thermally constrained, cost-sensitive devices. The processor is a mature option and remains a very popular choice for smart phones, digital TV, and both consumer and enterprise applications enabling the Internet of Things. The Cortex-A9 processor is available with a range of supporting ARM technology. The Cortex-A9 processor is designed for a range of products as a result of its scalable size and configuration options:

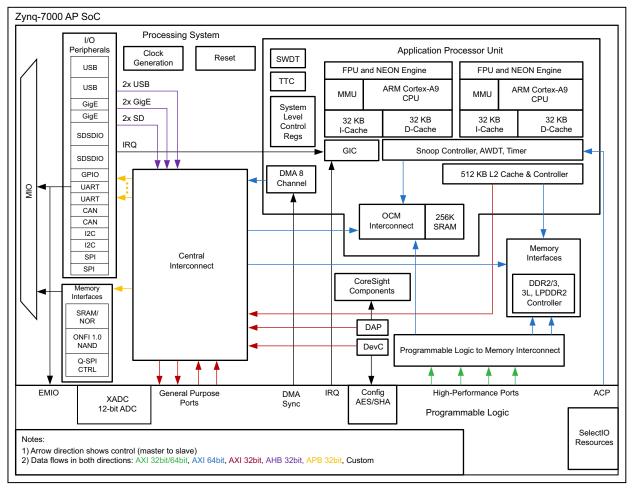
- Mainstream smart phones
- Tablets
- Set-top boxes
- Home media players
- Automotive infotainment
- Routers

The Zynq-7000 AP SoC family is based on Xilinx All Programmable SoC architecture. These products integrate a feature-rich dual-core ARM Cortex-A9 MPCore™ based processing system (PS) and Xilinx programmable logic (PL) in a single device, built on a state-of-the-art, high-performance, low-power (HPL), 28 nm, and high-k metal gate (HKMG) process technology. The ARM Cortex-A9 MPCore multicore processors are the heart of the PS, which also includes on-chip memory, external memory interfaces, and a rich set of I/O peripherals.



Porting Considerations

Figure 2-1 shows the Zynq®-7000 All Programmable (AP) SoC overview. In this diagram, the ARM® Cortex™-A9 processor and its components are shown.



X14719-061015

Figure 2-1: Zynq-7000 All Programmable SoC Overview

The ARM Cortex-A9 processor that is integrated into Zynq-7000 AP SoC is dual core. Each core contains separate L1 caches, however they share same L2 cache.



ARM Cortex-A9 Features

The ARM processor features that must be considered are listed in the following sections.

CPU Modes

At any given time, the CPU can be in only one mode, but it can switch modes due to external events (interrupts) or programmatically.

- User mode: The only non-privileged mode.
- FIQ mode: A privileged mode that is entered whenever the processor accepts an FIQ interrupt.
- IRQ mode: A privileged mode that is entered whenever the processor accepts an IRQ interrupt.
- Supervisor (svc) mode: A privileged mode entered whenever the CPU is reset or when an SVC instruction is executed.
- Abort mode: A privileged mode that is entered whenever a prefetch abort or data abort exception occurs.
- Undefined mode: A privileged mode that is entered whenever an undefined instruction exception occurs.
- System mode (ARMv4 and above): The only privileged mode that is not entered by an exception. It can only be entered by executing an instruction that explicitly writes to the mode bits of the Current Program Status Register (CPSR).
- Monitor mode (ARMv6 and ARMv7 Security Extensions, ARMv8 EL3): A monitor mode is introduced to support TrustZone® extension in ARM cores.
- Hyp mode (ARMv7 Virtualization Extensions, ARMv8 EL2): A hypervisor mode that supports virtualization requirements for the non-secure operation of the CPU.

TrustZone

The Security Extensions, marketed as TrustZone technology, is in Cortex-A9 architecture. It provides a low-cost alternative to adding another dedicated security core to an SoC by providing two virtual processors backed by hardware-based access control. This lets the application core switch between two states, referred to as *worlds* (to reduce confusion with other names for capability domains), to prevent information from leaking from the more trusted world to the less trusted world. This world switch is generally orthogonal to all other capabilities of the processor, thus each world can operate independently of the other while using the same core. Memory and peripherals are then made aware of the operating world of the core and can use this to provide access control to secrets and code on the device.



Typical applications of TrustZone technology are to run a rich operating system in the less trusted world, and smaller security-specialized code in the more trusted world, allowing much tighter digital rights management (DRM) for controlling the use of media on ARM-based devices and preventing any unapproved use of the device. In practice, however, other silicon vendors besides Xilinx often treat specific implementation details of ARM TrustZone hardware and associated software as confidential information. Because of that, it might be unclear what types of services are being provided by such third-party solutions. Analyzing the software stack implementation can provide more information about the secure world implementation.

Typical Application Examples

Some common applications based on TrustZone are listed by ARM in their TrustZone website and give a quick understanding of real world TrustZone usage [Ref 3]:

- Secured PIN entry for enhanced user authentication in mobile payments and banking
- Protection against trojans, phishing and advanced persistent threats (APT)
- Enable deployment and consumption of high-value media (DRM)
- Bring your own device (BYOD) device persons and application separation
- Software license management
- Loyalty-based applications
- Access control of cloud-based documents

Thumb-2 Instruction Set

In Thumb state, the processor executes the Thumb instruction set, a compact 16-bit encoding for a subset of the ARM instruction set. Most of the Thumb instructions are directly mapped to normal ARM instructions. The space-saving comes from making some of the instruction operands implicit and limiting the number of possibilities compared to the ARM instructions executed in the ARM instruction set state.

In Thumb, the 16-bit opcodes have less functionality. For example, only branches can be conditional, and many opcodes are restricted to accessing only half of all of the CPU's general-purpose registers. The shorter opcodes give improved code density overall, even though some operations require extra instructions. In situations where the memory port or bus width is constrained to less than 32 bits, the shorter Thumb opcodes allow increased performance compared with 32-bit ARM code, because less program code might need to be loaded into the processor over the constrained memory bandwidth.

Thumb-2 extends the limited 16-bit instruction set of Thumb with additional 32-bit instructions to give the instruction set more breadth, thus producing a variable-length instruction set. A stated aim for Thumb-2 was to achieve code density similar to Thumb with performance similar to the ARM instruction set on 32-bit memory.



SIMD Support (NEON)

The Advanced SIMD extension (aka NEON Media Processing Engine (MPE)) is a combined 64- and 128-bit SIMD instruction set that provides standardized acceleration for media and signal processing applications. NEON is included in Cortex-A9 of Zynq-7000 AP SoC. It features a comprehensive instruction set, separate register files, and independent execution hardware. NEON supports 8-, 16-, 32-, and 64-bit integer and single-precision (32-bit) floating-point data and single instruction multiple data (SIMD) operations for handling audio and video processing as well as graphics and gaming processing. In NEON, the SIMD supports up to 16 operations at the same time. The NEON hardware shares the same floating-point registers as used in VFP. NEON can execute 128 bits at a time, however though the ARM Cortex-A9 processor supports 128-bit vectors it executes with 64 bits at a time. NEON can execute MP3 audio decoding on CPUs running at 10 MHz and can run the GSM adaptive multi-rate (AMR) speech codec at no more than 13 MHz.

Vector Floating-Point Unit (VFPU) - Single and Double Precision

This is the floating-point coprocessor extension to the ARM architecture.

Caches

- L1 data cache 32 KB, L1 instruction cache 32 KB
 - Both are separate, 4-way set associative
- L2 512 KB cache (common to data and instruction)
 - 8-way set associative

MMU

The memory management unit (MMU) works with the L1 and L2 memory system to translate virtual addresses to physical addresses. It also controls accesses to and from external memory.

- Page table entries support 4 KB, 64 KB, 1 MB, and 16 MB.
- 16 domains.
- Global and application-specific identifiers remove the requirement for context switch translation look-aside buffer (TLB) flushes.
- Extended permissions check capability.

OCM

The on-chip memory (OCM) module contains 256 KB of RAM. It supports two 64-bit AXI slave interface ports, one dedicated to CPU/accelerator coherency port (ACP) access





through the application processing unit (APU) snoop control unit (SCU), and the other shared by all other bus masters within the processing system (PS) and programmable logic (PL). The bootROM memory is used exclusively by the boot process and is not visible to the user.

The address range assigned to the OCM can be modified to exist in the first or last 256 KB of the address map, to flexibly handle the ARM low or high exception vector modes. In addition, the CPU and ACP AXI interfaces can have their lowest 1 MB address range accesses diverted to DDR, using the SCU address filtering feature.

Interrupts

- Supported by Global Interrupt Controller (GIC) from ARM.
- 3 watch dog timers (WDTs)—1 for core0, 1 for core1, and 1 for system.
- Each core supports a few private peripheral interrupts (PPIs) and a few shared peripheral interrupts (SPIs).
- Interrupts can be prioritized.
- The CPU can go into a wait state (WFI) where it waits for an interrupt (or event) signal to be generated.

System Control Coprocessor (CP15)

The system control coprocessor, CP15, controls and provides status information for the functions implemented in the processor. The main functions of the system control coprocessor are:

- Overall system control and configuration
- MMU configuration and management
- Cache configuration and management
- System performance monitoring

Timers

Each Cortex-A9 processor core has its own private 32-bit timer and 32-bit watchdog timer. Both processor cores share a global 64-bit timer.

All these timers are always clocked at 1/2 of the CPU frequency (CPU 3x2x).

On the system level, there is a 24-bit watchdog timer and two 16-bit triple timer/counters. The system watchdog timer is clocked at 1/4 or 1/6 of the CPU frequency (CPU_1x), or can be clocked by an external signal from an MIO pin or from the PL.



The two triple timers/counters are always clocked at 1/4 or 1/6 of the CPU frequency (CPU_1x), and are used to count the widths of signal pulses from an MIO pin or from the PL.

Instruction Set

The ARM is a reduced instruction set computer (RISC) processor. The instruction set has the following features:

- Load/store architecture.
- Supports unaligned accesses for half-word and single-word load/store instructions with some limitations, such as no guaranteed atomicity.
- Uniform 16×32 -bit register file (including the Program Counter, Stack Pointer, and the Link Register).
- Fixed instruction width of 32 bits to ease decoding and pipelining, at the cost of decreased code density.
- The Thumb instruction set added 16-bit instructions and increased code density.
- Mostly single clock-cycle execution.

To compensate for the simpler design, compared with architectures like Intel, some additional design features were used:

- Conditional execution of most instructions reduces branch overhead and compensates for the lack of a branch predictor.
- Arithmetic instructions alter condition codes only when desired.
- 32-bit barrel shifter can be used without performance penalty with most arithmetic instructions and address calculations.
- Powerful indexed addressing modes.
- A link register supports fast leaf function calls.
- A simple but fast 2-priority-level interrupt subsystem has switched register banks.



Register Set

The register set is listed in the following table.

	Registers Across CPU Modes							
usr	usr sys svc abt und irq							
	RO							
	R1							
			R2					
			R3					
			R4					
			R5					
			R6					
			R7					
		R	8			R8_fiq		
	R9							
	R10							
		R1	11			R11_fiq		
		R1	12			R12_fiq		
R	13	R13_svc	R13_abt	R13_und	R13_irq	R13_fiq		
R	14	R14_svc	R14_abt	R14_und	R14_irq	R14_fiq		
	R15							
	CPSR							
		SPSR_svc	SPSR_abt	SPSR_und	SPSR_irq	SPSR_fiq		

Registers R0 through R7 are the same across all CPU modes; they are never banked.

R13 and R14 are banked across all privileged CPU modes except System mode. That is, each mode that can be entered because of an exception has its own R13 and R14. These registers generally contain the stack pointer and the return address from function calls, respectively.

Aliases

- R13 is also referred to as SP, the Stack Pointer.
- R14 is also referred to as LR, the Link Register.
- R15 is also referred to as PC, the Program Counter.



The Current Program Status Register (CPSR) has the following 32 bits:

- M (bits 0-4) is the processor mode bits.
- T (bit 5) is the Thumb state bit.
- F (bit 6) is the FIQ disable bit.
- I (bit 7) is the IRQ disable bit.
- A (bit 8) is the imprecise data abort disable bit.
- E (bit 9) is the data endianness bit.
- IT (bits 10-15 and 25-26) is the if-then state bits.
- GE (bits 16-19) is the greater-than-or-equal-to bits.
- DNM (bits 20-23) is the do not modify bits.
- J (bit 24) is the Java state bit.
- Q (bit 27) is the sticky overflow bit.
- V (bit 28) is the overflow bit.
- C (bit 29) is the carry/borrow/extend bit.
- Z (bit 30) is the zero bit.
- N (bit 31) is the negative/less than bit.

When you plan to move software from other architectures to ARM, there are certain mandatory and optional considerations, which are described in the next chapter.



Feature Comparison Across Architectures

Architectural Comparison

The architectures are compared in the following table.

Feature	ARMv7	PowerPC	MIPS	Renesas-SH	x86
Endianness	Big Little	Big Little	Big Little	Big Little	Little
Bits	Bits 32		64 (32→64) It is 64-bit architecture with a 32-bit subset.	32	16, 32, 64
Data bits	3	3	1, 2, 3	2	2 (integer) 3 (AVX-512)
Operands movement	Reg - Reg	Reg - Reg	Reg - Reg	Reg - Reg Reg - Mem	Reg - Mem
Design	RISC	RISC	RISC	RISC	CISC
Registers	16 (including PC, SP)	32	32 x 4 banks (including zero)	16	6 in 16-bit 8 in 32-bit 16 in 64-bit
Instruction bits	ARM: 32 bits Thumb: 16 bits Thumb2: 16–32 bits	32 bits	32 bits	16-32 bits	Variable
Extensions	NEON VFP TrustZone Jazelle LPAE	AltiVec, APU, VSX, Cell	MDMX MIPS-3D	None	x87, IA-32, MMX, 3DNow!, SSE, SSE2, PAE, x86-64, SSE3, SSE4, SSE5, AVX, AES, FMA



Function Calling Conventions

Usually source code is written in a high level language, such as C. In that case, the source code can be ported across architectures by changing the tool chain appropriately. The compilers take care of generating the machine code suitable for new architecture.

However, sometimes the code need to be fine-tuned for various optimizations. In that case, the developer needs to know the low level details such as code generation methods, registers usage, calling sequences, etc.

The function calling conventions across architectures are compared in the following table.

Convention	ARM	PowerPC	MIPS	Renesas-SH	x86
Function parameters	R0-R3	R3–R10 Subsequent args - stack	First 4 args - registers (\$a0–\$a3) Subsequent args - stack	R4–R7	Stack (ESS, ESP)
Order of parameters passed	Left to right	Left to right	Left to right	Left to right	Right to left
Normal return values	Register (R0)	R3	One register (\$v0)	R0	EIP
Long (complex) return value	Registers (R0–R4)	R3-R4	Two registers (\$v0, \$v1)	R0	EIP
Stack pointer	R13	R1	Register (\$sp)	R15	ESS, ESP
Return address	R14 (Link Reg)	LR (saved on stack)	Register (\$ra)	Register (PR)	EIP
How local variables are located	Stack	Stack	Stack	Stack	Stack
Non-preserved registers	R4–R8	R0, R2-R10, R12 FPR0-FPR13 LR, CTR, XER, CR0-CR7	\$0-\$15 \$24-\$25	R1–R7	All registers
Registers considered to be volatile	R4-R11	R3–R12	\$8-\$15 \$24-\$25	R1–R3	All registers



Setting Up For and Cleaning Up After a Function Call

The RISC processors (ARM, MIPS, PowerPC, and Renesas-SH) follow the standards ABI/EABI⁽¹⁾ for the function calling sequence, but with minor differences. Table 3-1 lists the calling procedure for each architecture.

Table 3-1: Function Calling Procedure for Each Architecture

Architecture	Prologue (prepare to invoke function call)	Epilogue (prepare to exit function call)
ARM	Push r4 to r11 to the stack. Push the return address in r14, to the stack. Copy args (r0–r3) to the local scratch regs (r4–r11). Allocate other local variables to the remaining local scratch regs (r4 to r11). Call other subroutines as necessary using BL.	Put the result in r0. Pull r4 to r11 from the stack. Pull the return address to the program counter r15.
MIPS	Reserve space for the stack frame. The stack frame can have 5 sections maximum: • Argument section, • Saved register section • Return address section • Padding section • Local data storage section. Set up a virtual frame pointer. The virtual frame pointer is sp(\$29) added to the frame size. Set a bit in the bitmask for each general purpose register saved. Store any registers that need to be saved. Set instruction pointer to function beginning. Start executing the function.	Place result in \$v0. Issue a restore for each register saved in the prologue. Return from the procedure.



 $^{{\}bf 1.}\ application\ binary\ interface/embedded-application\ binary\ interface$



Table 3-1: Function Calling Procedure for Each Architecture (Cont'd)

Architecture	Prologue (prepare to invoke function call)	Epilogue (prepare to exit function call)
	Called function is responsible for allocating its own stack frame, making sure to preserve 16-byte alignment in the stack.	Restores the nonvolatile general purpose and floating-point registers that were saved in the stack frame.
PowerPC	Decrements the stack pointer to account for the new stack frame and writes the previous value of the stack pointer to its own linkage area, which ensures the stack can be restored to its original state after returning from the call. Saves all nonvolatile general purpose and floating-point registers into the saved registers area. Saves the link register and condition register values in the caller's linkage area, if needed. The stack frame contain four sections, in the following order: Parameter area Linkage area Saved registers Local variables Execute the function code.	Nonvolatile registers are saved in the new stack frame before the stack pointer is updated, only when they fit within the space beneath the stack pointer, where a new stack frame would normally be allocated, also known as the <i>red zone</i> . The red zone is, by definition, large enough to hold all nonvolatile general purpose and floating-point registers but not the nonvolatile vector registers. Restores the condition register and link register values that were stored in the linkage area. Restores the stack pointer to its previous value. Returns control to the calling routine using the address stored in the link register.
x86	Pushes the old base pointer onto the stack. Gets new base pointer value which is set in the next step and is always pointed to this location. Assigns the value of stack pointer (which is pointed to the saved base pointer and the top of the old stack frame) into base pointer such that a new stack frame is created on top of the old stack frame (i.e., the top of the old stack frame becomes the base of the new stack frame). Moves the stack pointer further. The stack pointer is decreased to make room for variables (i.e., the function's local variables). Executes the function code.	Replaces the stack pointer with the current base (or frame) pointer, so the stack pointer is restored to its value before the prologue. Pops the base pointer off the stack, so it is restored to its value before the prologue. Returns to the calling function by popping the previous frame's program counter off the stack and jumping to it.
Renesas-SH	A sequence of zero or more instructions that save the incoming argument values from R4–R7 and FR4–FR11 to the argument home locations. A sequence of zero or more instructions that push all permanent registers to be saved and the return address (PR). A sequence of one or more instructions that set up the frame pointer. A sequence of zero or more instructions that allocate the remaining stack frame space for local variables, compiler-generated temporaries, and the argument-build area by subtracting a 4-byte aligned offset from R15. Execute the function code.	A single add instruction that increments the frame pointer. A sequence of instructions that modify R15 by referencing it in the destination operand of the instruction or in a post-increment memory address operand of the instruction.



The following sections describe architectural considerations.

Interrupt Models

The interrupt sources in these architectures do not follow a specific standard. Each of them have defined their set of exceptions based on the resources available and their target applications.

However, they are broadly divided into 2 groups—software exceptions and external events. The following table describes the interrupts of each architecture in these two groups.

Type of Exception	ARM	MIPS	PowerPC	x86	Renesas-SH
Exceptions due to instructions	SWI Undefined instruction Prefetch abort Data abort	SYS OV TR	Critical input Machine check System call	Divide error Break point Invalid opcode Segment not present Stack segment fault General protection fault Page fault Machine check	TRAP, UBRKAFTER
Exceptions due to external world	Reset IRQ FIQ	Reset NMI Interrupt AdEL AdES TLBL TLBS ICache error DCache error	Data storage Instruction storage External alignment program Floating point PITimer FITimer WDTimer TLB Miss Debug	NMI User-defined interrupts	Reset: POWERON, MANRESET, HUDIReset, ITLBMULTIHIT, OLTBMULTIHIT General: UBRKBEFORE, IADDERR, ITLBMISS, EXECPROT, RESINST, ILLSLOT, FPUDIS, SLOTFPUDIS, RADDERR, WADDERR, WADDERR, READPROT, FPUEXC, FIRSTWRITE Interrupt: NMI, IRLINT, PERIPHINT



Address Maps

ARM Cortex-A9 Address Maps in the Zynq-7000 AP SoC

Table 3-2 shows the system-level address map. Refer to *Zynq-7000 All Programmable SoC Technical Reference Manual* (UG585) [Ref 1] for more details on the ARM system address map.

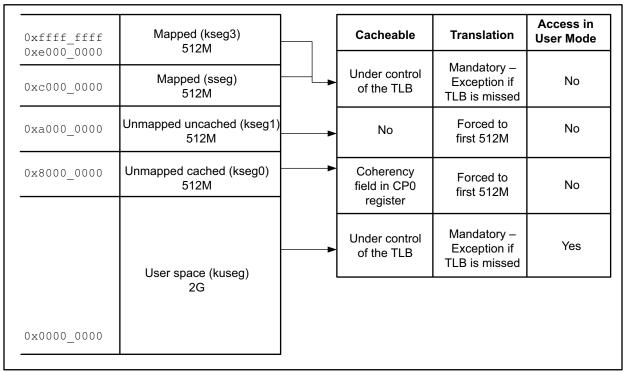
Table 3-2: System-Level Address Map

Address Range	CPUs and ACP	AXI_HP	Other Bus Masters	Notes
	ОСМ	ОСМ	ОСМ	Address not filtered by SCU and OCM is mapped low
	DDR	ОСМ	ОСМ	Address filtered by SCU and OCM is mapped low
0000_0000 to 0003_FFFF	DDR			Address filtered by SCU and OCM is not mapped low
				Address not filtered by SCU and OCM is not mapped low
0004 0000 to 0007 BEEF	DDR			Address filtered by SCU
0004_0000 to 0007_FFFF				Address not filtered by SCU
0000 0000 to 0000 BEEF	DDR	DDR	DDR	Address filtered by SCU
0008_0000 to 000F_FFFF		DDR	DDR	Address not filtered by SCU
0010_0000 to 3FFF_FFFF	DDR	DDR	DDR	Accessible to all interconnect masters
4000_0000 to 7FFF_FFFF	PL		PL	General Purpose Port #0 to the PL, M_AXI_GP0
8000_0000 to BFFF_FFFF	PL		PL	General Purpose Port #1 to the PL, M_AXI_GP1
E000_0000 to E02F_FFFF	IOP		IOP	I/O Peripheral registers
E100_0000 to E5FF_FFFF	SMC		SMC	SMC Memories
F800_0000 to F800_0BFF	SLCR		SLCR	SLCR registers
F800_1000 to F880_FFFF	PS		PS	PS System registers
F890_0000 to F8F0_2FFF	CPU			CPU Private registers
FC00_0000 to FDFF_FFFF	Quad-SPI		Quad-SPI	Quad-SPI linear address for linear mode
EDEC 0000 to EDED FORD	ОСМ	ОСМ	ОСМ	OCM is mapped high
FFFC_0000 to FFFF_FFFF				OCM is not mapped high



MIPS

Figure 3-1 describes the MIPS memory map.



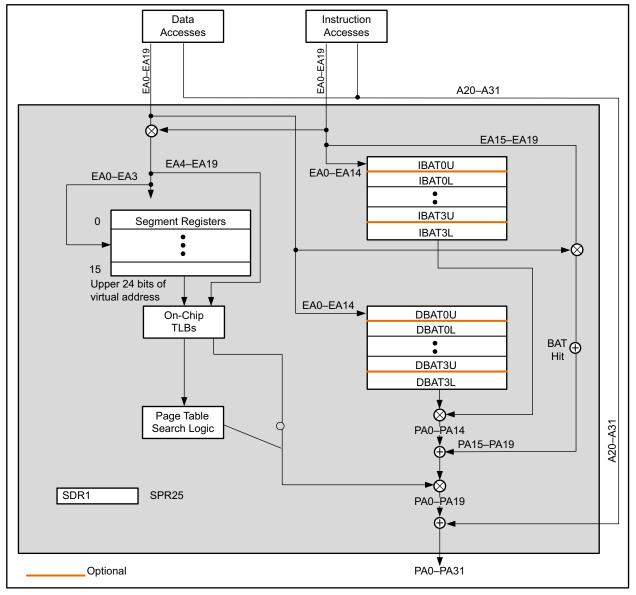
X14720-061015

Figure 3-1: MIPS Memory Map



PowerPC

Figure 3-2 shows a concept block diagram for the MMU.



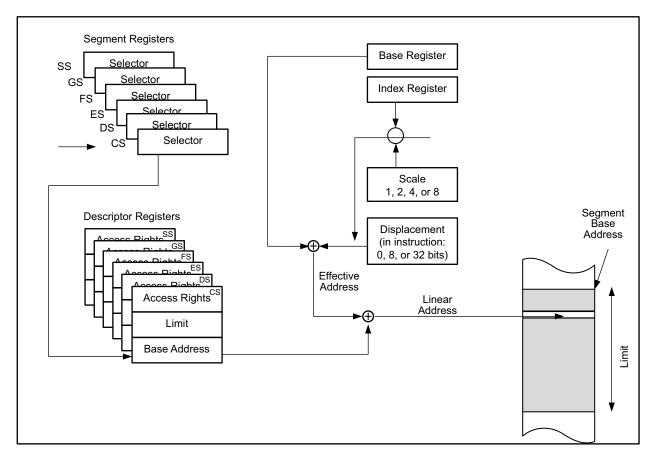
X14721-061015

Figure 3-2: MMU Conceptual Block Diagram



x86

Figure 3-3 describes the x86 address mechanism.



X14722-061015

Figure 3-3: x86 Address Mechanism



Renesas-SH

Figure 3-4 describes the Renesas-SH memory map.

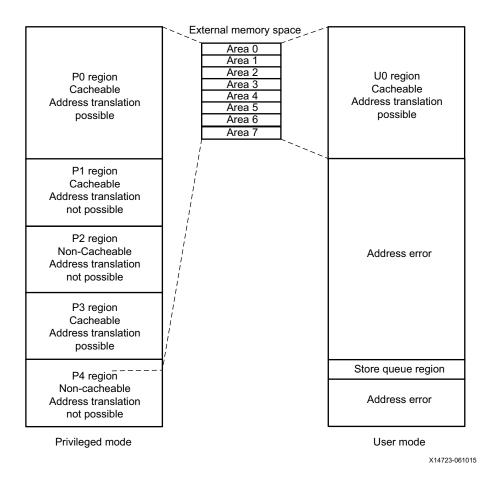


Figure 3-4: Renesas-SH Memory Map



Register Sets

The following table lists major features of register sets for ARM, MIPS, PowerPC, x86, and Renesas-SH processors.

Register Type	ARM	MIPS	PowerPC	x86	Renesas-SH
General purpose registers	R0-R12	\$8-\$15, \$24, \$25: temporary (not saved) \$16-\$23: temporary (saved)	User model (UISA) GPR0-31 FPR0-31 CR FPSCR XER LR CTR TBU/TBL	General: EAX, EBX, ECX, EDX Segment: CS, DS, ES, FS, GS, SS Index: ESI, EDI, EBP, EIP, ESP Indicator: EFLAGS	General, banked: R0–R7 General, non-banked: R8-R15 Floating, banked: FR0-15, XF0-15
Specific usage registers	R13: stack pointer R14: link register R15: program counter	\$0: wired to zero \$1: reserved for assembler \$2, \$3: function return values \$4-\$7: function arguments \$26, \$27: reserved for OS \$28: global pointer \$29: stack pointer \$30: frame pointer (saved) \$31: link register	None	None	Control registers: SR, GBR, SSR, SPC, SGR, DBR, VBR System registers: MACH, MACL, PR, FUPL, PC, FPSCR
Special purpose registers	System coprocessor CP15	\$SR, \$PC, GBR, VBR, SGR, DBR, MACL, MACH, PR, PC, FPUL, FPSCR, TRA, EXPEVT, INTEVT, PTEH, PTEL, TTB, TEA, MMUCR, PASCR, IRMCR, CCR, QACR0/1, RAMCR, LSA0/1, LDA0/1, CPUPOM, PVR	Supervisor mode (OEA) MSR PVR SDR1 ASR DAR DSISR SRR0-1 SPRG0-3 FPECR DABR DEC EAR PIR	Control: CR0-4 Debug: DR0-7 Test: TR0-7 GDTR, IDTR, LDTR, TR	None



Detailed Porting Guides: MIPS, PowerPC, Intel, and Renesas

When considering porting to a Xilinx Zynq-7000 device, which is an ARM Cortex-A9 based SoC, see *UltraFast Embedded Design Methodology Guide* (UG1046) [Ref 2], which contains details about:

- System level considerations
- Hardware design considerations
- Software design considerations
- Hardware design flow
- Software design flow
- Debugging techniques
- SDSoC environment

This methodology guide supports porting user applications from non-ARM platforms to the ARM platform.

Port from MIPS to ARM

For a detailed explanation, see Migrating from MIPS to ARM at the ARM site.

Port from PowerPC to ARM

For a detailed explanation, see Migrating from Power Architecture to ARM at the ARM site.

Port from Intel IA-32 to ARM

For a detailed explanation, see Migrating from IA-32 to ARM at the ARM site.

Port from Renesas-SH to ARM

For a detailed explanation, see AN314 Migrating from SH-4A to Cortex-A at the ARM site.



Additional Resources and Legal Notices

Xilinx Resources

For support resources such as Answers, Documentation, Downloads, and Forums, see Xilinx Support.

Solution Centers

See the <u>Xilinx Solution Centers</u> for support on devices, software tools, and intellectual property at all stages of the design cycle. Topics include design assistance, advisories, and troubleshooting tips.

References

- 1. Zyng-7000 All Programmable SoC Technical Reference Manual (UG585)
- 2. UltraFast Embedded Design Methodology Guide (UG1046)
- 3. ARM TrustZone Technology (www.arm.com/products/processors/technologies/trustzone/index.php)

Please Read: Important Legal Notices

The information disclosed to you hereunder (the "Materials") is provided solely for the selection and use of Xilinx products. To the maximum extent permitted by applicable law: (1) Materials are made available "AS IS" and with all faults, Xilinx hereby DISCLAIMS ALL WARRANTIES AND CONDITIONS, EXPRESS, IMPLIED, OR STATUTORY, INCLUDING BUT NOT LIMITED TO WARRANTIES OF MERCHANTABILITY, NON-INFRINGEMENT, OR FITNESS FOR ANY PARTICULAR PURPOSE; and (2) Xilinx shall not be liable (whether in contract or tort, including negligence, or under any other theory of liability) for any loss or damage of any kind or nature related to, arising under, or in connection with, the Materials (including your use of the Materials), including for any direct, indirect, special, incidental, or consequential loss or damage (including loss of data, profits, goodwill, or any type of loss or damage suffered as a result of any action brought by a third party) even if such damage or loss was reasonably foreseeable or Xilinx had been advised of the possibility of the same. Xilinx assumes no obligation to correct any errors contained in the Materials or to notify you of updates to the Materials or to product specifications. You may not reproduce, modify, distribute, or publicly display the Materials without prior written consent. Certain products are subject to the terms and conditions of Xilinx's limited warranty, please refer to Xilinx's Terms of Sale which can be viewed at http://www.xilinx.com/legal.htm#tos; IP cores may be subject to warranty and support terms contained in a license issued to you by Xilinx. Xilinx products are not designed or intended to be



fail-safe or for use in any application requiring fail-safe performance; you assume sole risk and liability for use of Xilinx products in such critical applications, please refer to Xilinx's Terms of Sale which can be viewed at http://www.xilinx.com/legal.htm#tos.

Automotive Applications Disclaimer

XILINX PRODUCTS ARE NOT DESIGNED OR INTENDED TO BE FAIL-SAFE, OR FOR USE IN ANY APPLICATION REQUIRING FAIL-SAFE PERFORMANCE, SUCH AS APPLICATIONS RELATED TO: (I) THE DEPLOYMENT OF AIRBAGS, (II) CONTROL OF A VEHICLE, UNLESS THERE IS A FAIL-SAFE OR REDUNDANCY FEATURE (WHICH DOES NOT INCLUDE USE OF SOFTWARE IN THE XILINX DEVICE TO IMPLEMENT THE REDUNDANCY) AND A WARNING SIGNAL UPON FAILURE TO THE OPERATOR, OR (III) USES THAT COULD LEAD TO DEATH OR PERSONAL INJURY. CUSTOMER ASSUMES THE SOLE RISK AND LIABILITY OF ANY USE OF XILINX PRODUCTS IN SUCH APPLICATIONS.

© Copyright 2015 Xilinx, Inc. Xilinx, the Xilinx logo, Artix, ISE, Kintex, Spartan, Virtex, Vivado, Zynq, and other designated brands included herein are trademarks of Xilinx in the United States and other countries. ARM is a registered trademark of ARM in the EU and other countries. The PowerPC name and logo are registered trademarks of IBM Corp. and used under license. All other trademarks are the property of their respective owners.